

**REMARKS**

An error is found in Fig. 2C, therefore the Applicants have amended Fig. 2C to label the numeral of the element “pits” as 218 instead of 218a. The amendments are well supported by paragraph [0025]. Further, the statement “the second dielectric layer” recited in claim 17 lacks antecedent, therefore Applicants have amended the statement “the second dielectric layer” to “the first material layer”. No new matters have been added to the application and figures by the amendment made herein.

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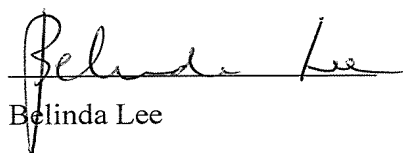
CONCLUSION

For at least the foregoing reasons, it is believed that the pending claims are in proper condition for allowance. If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

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Respectfully submitted,

  
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